



Main page > Repair Equipment > Soldering Equipment > Platform reballing BGA > AMAOE Mbga-B BGA reballing platform with stencils for CPU

AMAOE Mbga-B BGA reballing platform with stencils for CPU

Product ID: 22944

Price: **49.00 EUR**

Product weight: **1.00 kg**

Description:

AMAOE Mbga-B BGA reballing platform with stencils for CPU - Reballing platforms are high-quality products that enable precise re-creation of balls connecting the upper and lower parts of the motherboard and for removing glue. Made of high-quality synthetic stone, resistant to high temperatures and quickly cooling down. Platforms equipped with very strong magnets that prevent movement during soldering work using templates / reballing sieves. For CPU Hi3680 Hi3660 Hi3670 Hi3690 HI6290 HI36A0 RAM BGA366/376/436

Contact details:

Telefon: +48 17 227 00 25

Infolinia: 0 801 671 717

E-mail: biuro@multi-com.pl

Skype: Multi-COM

Address:

Multi-COM Sp. z o.o.

ul. Stanisława Krzaklewskiego 31b

36-100 Kolbuszowa

POLSKA

[Go to the product](#)

